



Fiber Optics

Small Form Factor Multimode 850 nm 2.125 and 1.0625 GBd Fibre Channel 2x5 Transceiver with LC™ Connector

V23818-M305-L57

Features

- Small Form Factor transceiver
- Full compliant with Fibre Channel
- Data rate autonegotiation between 1.0625 and 2.125 GBd
- Excellent EMI performance
- RJ-45 style LC™ connector system
- Half the size of SC Duplex 1x9 transceiver
- Single power supply (3.3 V)
- Extremely low power consumption of 445 mW typical
- PECL and LVPECL differential inputs and outputs
- System optimized for 62.5/50 μm graded index fiber
- Multisource 2x5 footprint
- Small size for high port density
- UL-94 V-0 certified
- ESD Class 1 per MIL-STD 883D Method 3015.7
- Compliant with FCC (Class B) and EN 55022
- For distances of up to 700 m
- Class 1 FDA and IEC laser safety compliant
- AC/AC coupling in accordance to SFF MSA
- Operating case temperature: -10°C to 85°C



LC™ is a trademark of Lucent

Part Number	Voltage	Signal Detect	Input	Output
V23818-M305-L57	3.3 V	TTL	AC	AC

Pin Configuration

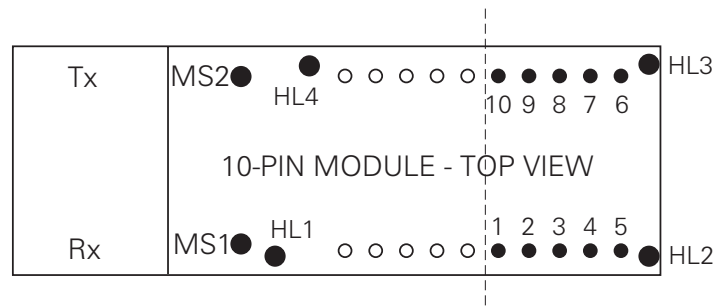


Figure 1

Pin Configuration

Pin Description

Pin No.	Symbol	Level/Logic	Function	Description
1	V_{EEr}	N/A	Receiver Signal Ground	
2	V_{CCr}	N/A	Receiver Power Supply	
3	SD	TTL	Signal Detect	Normal Operation: Logic "1" Output, represents that light is present at receiver input Fault Condition: Logic "0" Output
4	RD–	PECL	Received Data Out Not	
5	RD+	PECL	Received Data Out	
6	V_{CCt}	N/A		Transmitter Power Supply
7	V_{EEt}	N/A		Transmitter Signal Ground
8	TxDis	TTL Input	Transmitter Disable/Enable	A low signal switches the laser on. A high signal switches the laser off.
9	TD+	PECL	Transmit Data	Transmitter Data In
10	TD–	PECL	Transmit Data Not	Transmitter Data In
MS1 MS2	MS	N/A	Mounting Studs	Mounting Studs are provided for transceiver mechanical attachment to the circuit board. They also provide an optional connection of the transceiver to the equipment chassis ground.
HL1 HL2 HL3 HL4	HL	N/A	Housing Leads	The transceiver Housing Leads are provided for additional signal grounding. The holes in the circuit board must be included and be tied to signal ground (see "Application Notes" on Page 11).

Description
Description

The Infineon Fibre Channel multimode transceiver – part of Infineon Small Form Factor transceiver family – is based on the Physical Medium Depend (PMD) sublayer and baseband medium, type (short wavelength), Fibre Channel

FC-PI 200-M5-SN-I, 200-M6-SN-I

FC-PI 100-M5-SN-I, 100-M6-SN-I

FC-PH2 100-M5-SN-I, FC-PH2 100-M6-SN-I.

The appropriate fiber optic cable is 62.5 µm or 50 µm multimode fiber with LC™ connector.

Operating Range over each Optical Fiber Type

Fiber Type	Limit Values			Unit
	min.	typ.	max.	
at 2.125 GBd				
62.5 micron MMF	0.5	2 to 150	300	meters
50.0 micron MMF	0.5	2 to 300	500	
at 1.0625 GBd				
62.5 micron MMF	0.5	2 to 300	400	meters
50.0 micron MMF	0.5	2 to 550	700	

The Infineon Fibre Channel multimode transceiver is a single unit comprised of a transmitter, a receiver, and an LC™ receptacle. This design frees the customer from many alignment and PC board layout concerns.

This transceiver supports the LC™ connectorization concept. It is compatible with RJ-45 style backpanels for high end Data Com and Telecom applications while providing the advantages of fiber optic technology.

The module is designed for low cost SAN, LAN, WAN, Fibre Channel applications. It can be used as the network end device interface in mainframes, workstations, servers, and storage devices, and in a broad range of network devices such as bridges, routers, hubs, and local and wide area switches.

This transceiver operates at 1.0625/2.125 Gbit/s from a single power supply (+3.3 V). The full differential data inputs and outputs are PECL and LVPECL compatible.

Functional Description of 2x5 Pin Row Transceiver

This transceiver is designed to transmit serial data via multimode cable.

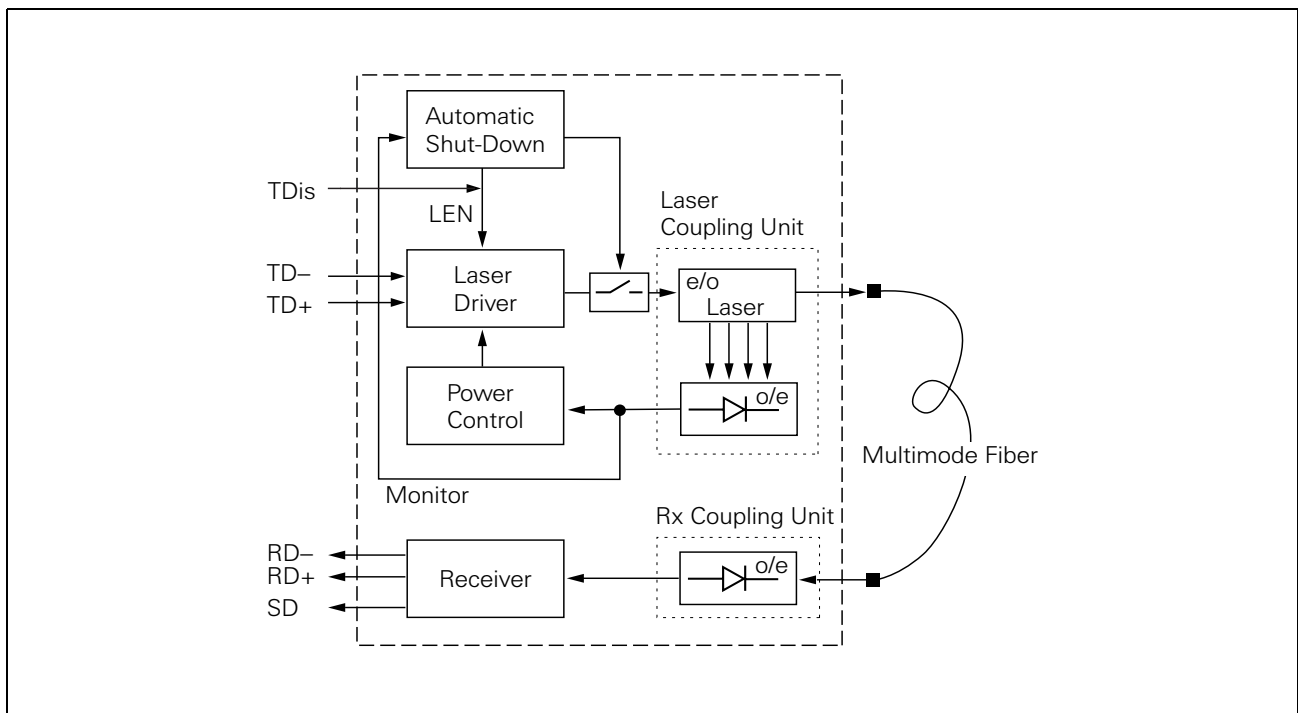


Figure 2 Functional Diagram

The receiver component converts the optical serial data into PECL compatible electrical data (RD+ and RD-). The Signal Detect (SD, active high) shows whether an optical signal is present.

The transmitter converts PECL compatible electrical serial data (TD+ and TD-) into optical serial data. Data lines are differentially 100 Ω terminated.

The transmitter contains a laser driver circuit that drives the modulation and bias current of the laser diode. The currents are controlled by a power control circuit to guarantee constant output power of the laser over temperature and aging.

The power control uses the output of the monitor PIN diode (mechanically built into the laser coupling unit) as a controlling signal, to prevent the laser power from exceeding the operating limits.

Single fault condition is ensured by means of an integrated automatic shutdown circuit that disables the laser when it detects laser fault to guarantee the laser Eye Safety.

The transceiver contains a supervisory circuit to control the power supply. This circuit makes an internal reset signal whenever the supply voltage drops below the reset threshold. It keeps the reset signal active for at least 140 milliseconds after the voltage has risen above the reset threshold. During this time the laser is inactive.

A low signal on TxDis enables transmitter. If TxDis is high the transmitter is disabled.

Description
Regulatory Compliance

Feature	Standard	Comments
ESD: Electrostatic Discharge to the Electrical Pins	EIA/JESD22-A114-A (MIL-STD 883D Method 3015.7)	Class 1 (>1000 V)
Immunity: Against Electrostatic Discharge (ESD) to the Duplex LC Receptacle	EN 61000-4-2 IEC 61000-4-2	Discharges ranging from ± 2 kV to ± 15 kV on the receptacle cause no damage to transceiver (under recommended conditions).
Immunity: Against Radio Frequency Electromagnetic Field	EN 61000-4-3 IEC 61000-4-3	With a field strength of 3 V/m rms, noise frequency ranges from 10 MHz to 2 GHz. No effect on transceiver performance between the specification limits.
Emission: Electromagnetic Interference (EMI)	FCC 47 CFR Part 15, Class B EN 55022 Class B CISPR 22	Noise frequency range: 30 MHz to 18 GHz

Technical Data
Absolute Maximum Ratings

Parameter	Symbol	Limit Values		Unit
		min.	max.	
Package Power Dissipation			0.5	W
Data Input Levels (PECL)			$V_{CC}+0.5$	V
Differential Data Input Voltage			2.5	
Storage Ambient Temperature		-40	85	°C
Soldering Conditions, Temp/Time (MIL-STD 883C, Method 2003)			250/ 5.5	°C/s
V_{CC} max.			5.5	V
ECL-Output current data			50	mA

Exceeding any one of these values may destroy the device immediately.

Recommended Operating Conditions

Parameter	Symbol	Limit Values			Unit
		min.	typ.	max.	
Case Temperature	T_C	-10		85	°C
Power Supply Voltage	$V_{CC}-V_{EE}$	3.1	3.3	3.5	V

Transmitter

Data Input Differential Voltage	V_{DIFF}	250		2400	mV
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Receiver

Input Center Wavelength	λ_C	770		860	nm
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Technical Data

The electro-optical characteristics described in the following tables are valid only for use under the recommended operating conditions.

Transmitter Electro-Optical Characteristics

Parameter		Symbol	Limit Values			Unit
			min.	typ.	max.	
Launched Power (Average) ¹⁾		P_O	−9.5	−6	−4	dBm
Optical Modulation Amplitude ²⁾	2.125 Gbit/s	OMA	196	450		μW
	1.0625 Gbit/s		156	450		
Center Wavelength		λ_C	830	850	860	nm
Spectral Width (RMS)		σ_I			0.85	
Relative Intensity Noise		RIN			−117	dB/Hz
Extinction Ratio (Dynamic)		ER	9	13		dB
Total Tx Jitter		TJ		40	80	ps
Reset Threshold ³⁾		V_{TH}	2.5	2.75	2.99	V
Reset Time Out ³⁾		t_{RES}	140	240	560	ms
Rise Time, 20%–80%		t_R		130	150	ps
Supply Current				45	65	mA

¹⁾ Into multimode fiber, 62.5 μm or 50 μm diameter.

²⁾ Fibre Channel PI Standard.

³⁾ Laser power is shut down if power supply is below V_{TH} and switched on if power supply is above V_{TH} after t_{RES} .

Receiver Electro-Optical Characteristics

Parameter		Symbol	Limit Values			Unit
			min.	typ.	max.	
Sensitivity (Average Power) ¹⁾	2.125 Gbit/s	P_{IN}		−18.5	−16	dBm
	1.0625 Gbit/s			−19	−17	
Saturation (Average Power)		P_{SAT}	0			
Min. Optical Modulation Amplitude ²⁾	2.125 Gbit/s	OMA		24	49	μW
	1.0625 Gbit/s			19	31	
Stressed Receiver Sensitivity 50 μm Fiber ³⁾	2.125 Gbit/s	S_{PIN}		29	96	
	1.0625 Gbit/s			24	55	
Stressed Receiver Sensitivity 62.5 μm Fiber ³⁾	2.125 Gbit/s	S_{PIN}		34	109	
	1.0625 Gbit/s			32	67	
Signal Detect Assert Level ⁴⁾		P_{SDA}		−21	−18	dBm
Signal Detect Deassert Level ⁵⁾		P_{SDD}	−30	−22		
Signal Detect Hysteresis		$P_{\text{SDA}}-P_{\text{SDD}}$	0.5	1		dB
Signal Detect Assert Time		t_{ASS}			100	μs
Signal Detect Deassert Time		t_{DAS}			350	
Receiver 3 dB cut-off Frequency ²⁾					2.5	GHz
Receiver 10 dB cut-off Frequency ²⁾					6	
Data Output Differential Voltage ⁶⁾		V_{DIFF}	0.5	0.7	1.23	V
Return Loss of Receiver		A_{RL}	12			dB
Supply current ⁷⁾				80	90	mA

¹⁾ Average optical power at which the BER is 1×10^{-12} . Measured with a 2^7-1 NRZ PRBS and ER = 9 dB.

²⁾ Fibre Channel PI Standard.

³⁾ Measured at the given Stressed Receiver Eyeclosure Penalty and DCD component given in Fibre Channel PI Standard (2.03/2.18 dB & 40/80 ps).

⁴⁾ An increase in optical power above the specified level will cause the SIGNAL DETECT output to switch from a Low state to a High state.

⁵⁾ A decrease in optical power below the specified level will cause the SIGNAL DETECT to change from a High state to a Low state.

⁶⁾ AC/AC for data. Load 50 Ω to GND or 100 Ω differential. For dynamic measurement a tolerance of 50 mV should be added.

⁷⁾ Supply current excluding Rx output load.

Eye Safety

Eye Safety

This laser based multimode transceiver is a Class 1 product.

It complies with IEC 60825-1 and FDA 21 CFR 1040.10 and 1040.11.

To meet laser safety requirements the transceiver shall be operated within the Absolute Maximum Ratings.

Attention: All adjustments have been made at the factory prior to shipment of the devices. No maintenance or alteration to the device is required.

Tampering with or modifying the performance of the device will result in voided product warranty.

Note: Failure to adhere to the above restrictions could result in a modification that is considered an act of “manufacturing”, and will require, under law, recertification of the modified product with the U.S. Food and Drug Administration (ref. 21 CFR 1040.10 (i)).

Laser Data

Wavelength	850 nm
Total output power (as defined by IEC: 7 mm aperture at 1.4 cm distance)	<675 μ W
Total output power (as defined by FDA: 7 mm aperture at 20 cm distance)	<70 μ W
Beam divergence	12°

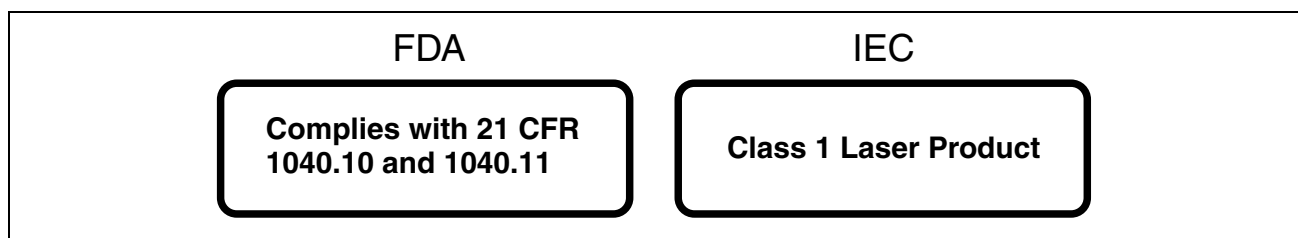


Figure 3 Required Labels

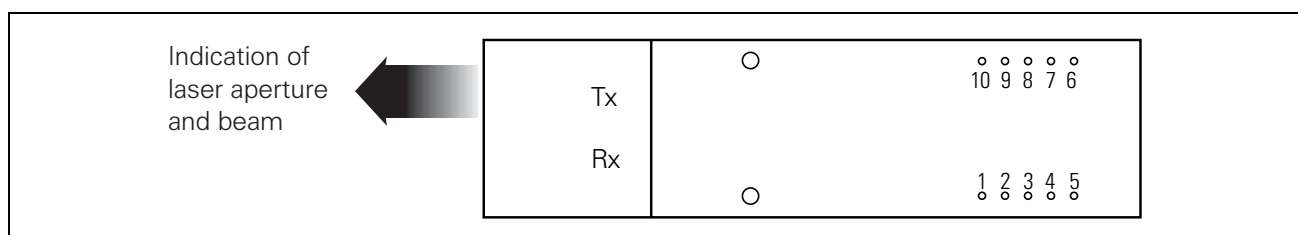


Figure 4 Laser Emission

Application Notes

Small Form Factor Pinning Comparison

The drawing below gives you a comparison between the different pinnings 2x5, 2x6, 2x10. Dimension for diameter and distance of additional pins is similar to the existing dimensions of the other pins.

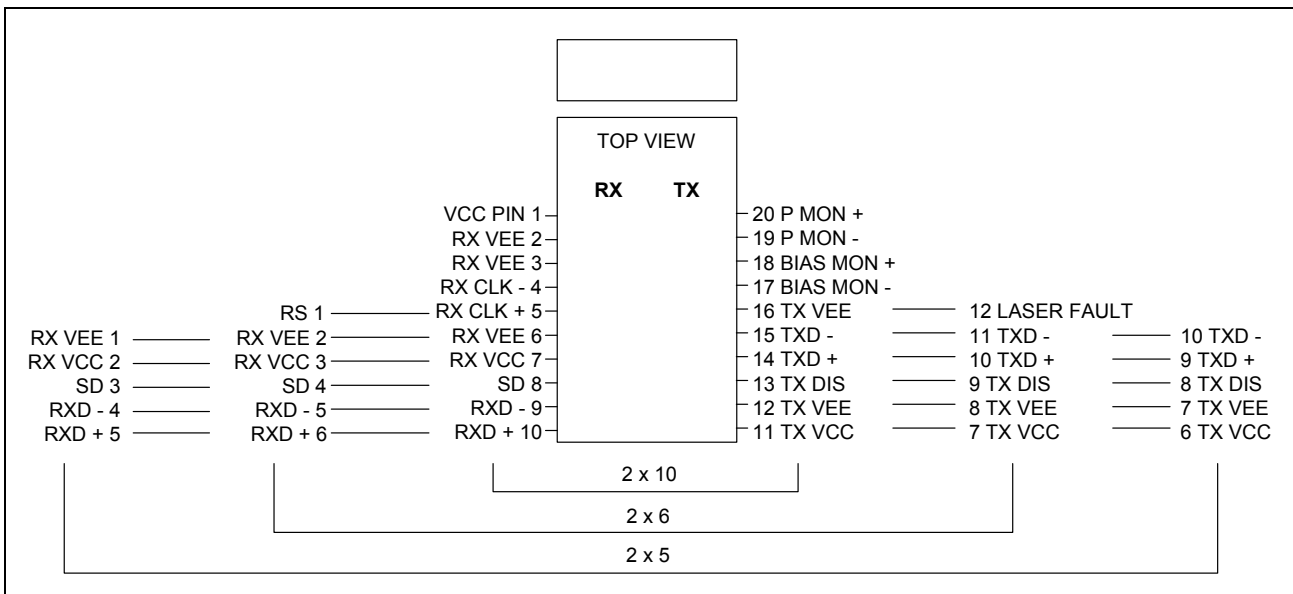


Figure 5

Pin Description

RS pin - The RS Rate Select: is not connected.

LF pin - The LF pin (Laser Fault) is a TTL output of the Laser Driver Supervisor Circuit. A Logic "1" level can be measured in case of a laser fault. It will not show a fault if the laser is being disabled using the TxDis input, since this is not a fault condition.

EMI-Recommendation

To avoid electromagnetic radiation exceeding the required limits please take note of the following recommendations.

When Gigabit switching components are found on a PCB (multiplexers, clock recoveries etc.) any opening of the chassis may produce radiation also at chassis slots other than that of the device itself. Thus every mechanical opening or aperture should be as small as possible.

On the board itself every data connection should be an impedance matched line (e.g. strip line, coplanar strip line). Data, Datanot should be routed symmetrically, vias should be avoided. A terminating resistor of 100 Ω should be placed at the end of each matched

Application Notes

line. An alternative termination can be provided with a $50\ \Omega$ resistor at each (D, Dn). In DC coupled systems a thevenin equivalent $50\ \Omega$ resistance can be achieved as follows: For 3.3 V: $125\ \Omega$ to V_{CC} and $82\ \Omega$ to V_{EE} , for 5 V: $82\ \Omega$ to V_{CC} and $125\ \Omega$ to V_{EE} at Data and Datanot. Please consider whether there is an internal termination inside an IC or a transceiver.

In certain cases signal GND is the most harmful source of radiation. Connecting chassis GND and signal GND at the plate/ bezel/ chassis rear e.g. by means of a fiber optic transceiver may result in a large amount of radiation. Even a capacitive coupling between signal GND and chassis may be harmful if it is too close to an opening or an aperture.

If a separation of signal GND and chassis GND is not possible, it is strongly recommended to provide a proper contact between signal GND and chassis GND at every location where possible. This concept is designed to avoid hotspots. Hotspots are places of highest radiation which could be generated if only a few connections between signal and chassis GND exist. Compensation currents would concentrate at these connections, causing radiation.

By use of Gigabit switching components in a design, the return path of the RF current must also be considered. Thus a split GND plane of Tx and Rx portion may result in severe EMI problems.

A recommendation is to connect the housing leads to signal GND. However, in certain applications it may improve EMI performance by connecting them to chassis GND.

The cutout should be sized so that all contact springs make good contact with the face plate.

Please consider that the PCB may behave like a waveguide. With an ϵ_r of 4, the wavelength of the harmonics inside the PCB will be half of that in free space. In this scenario even the smallest PCBs may have unexpected resonances.

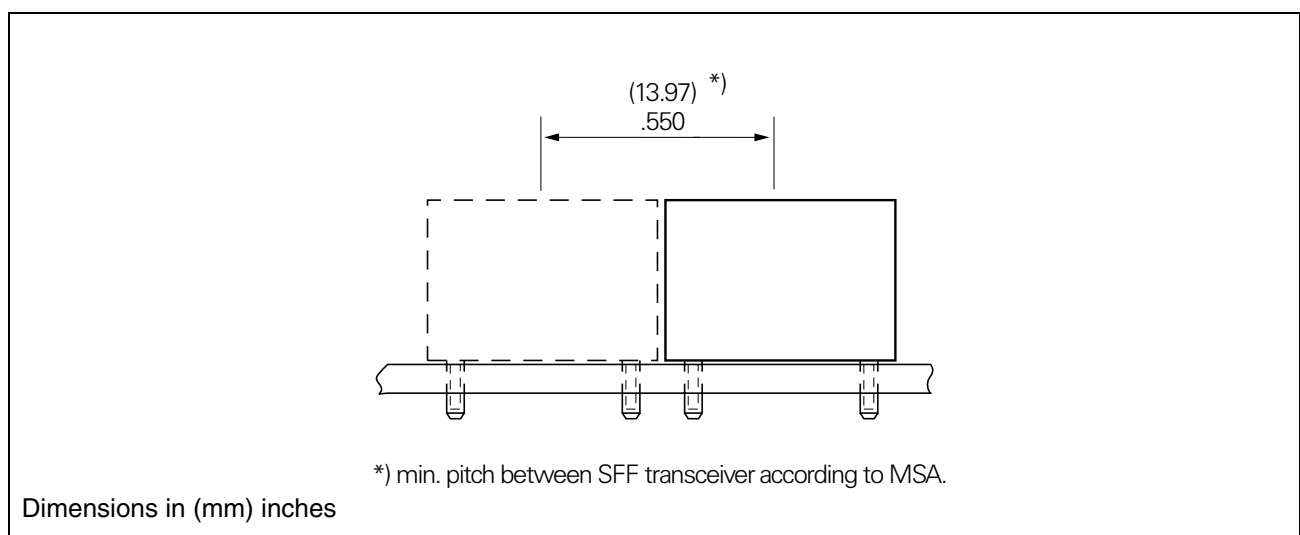
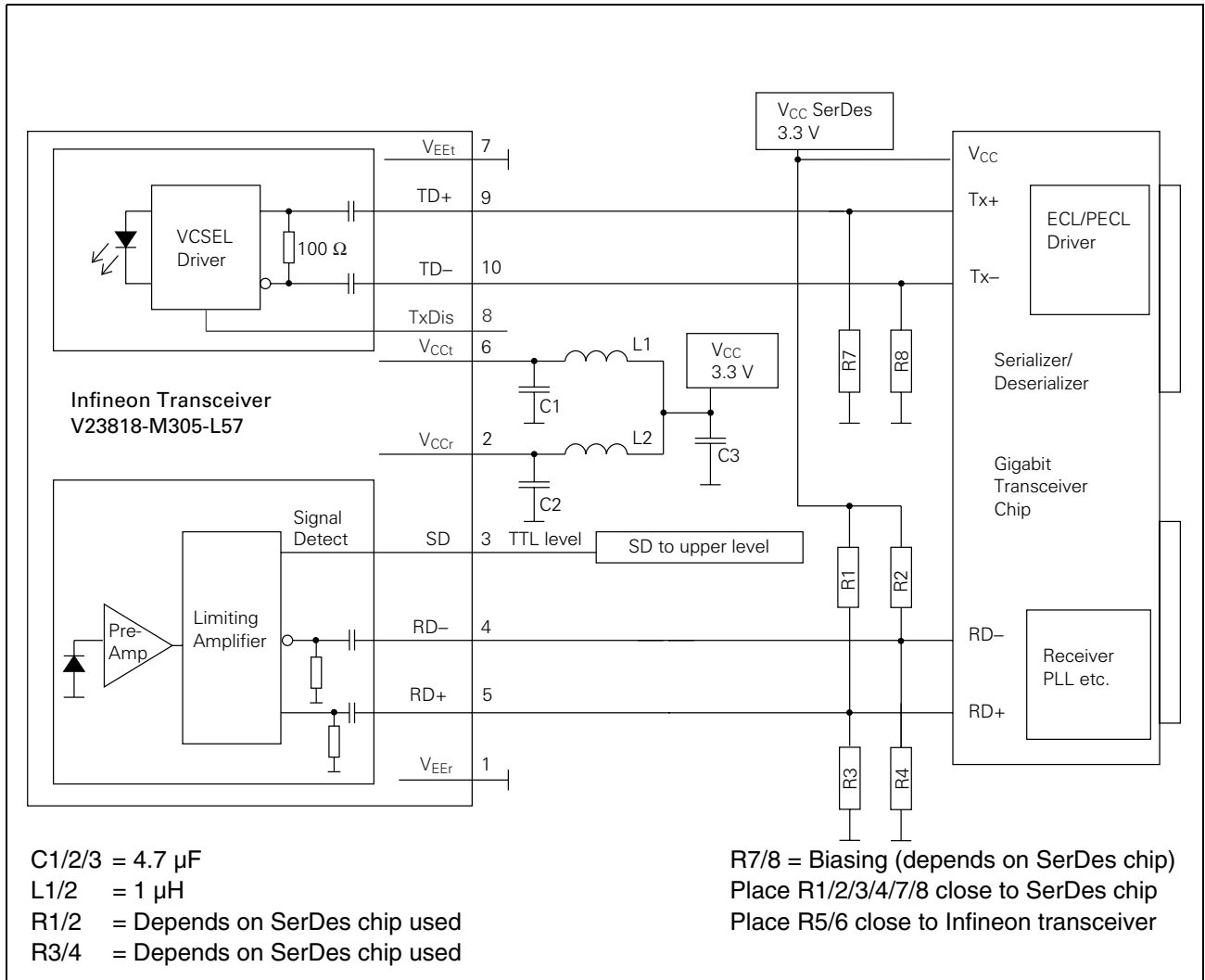
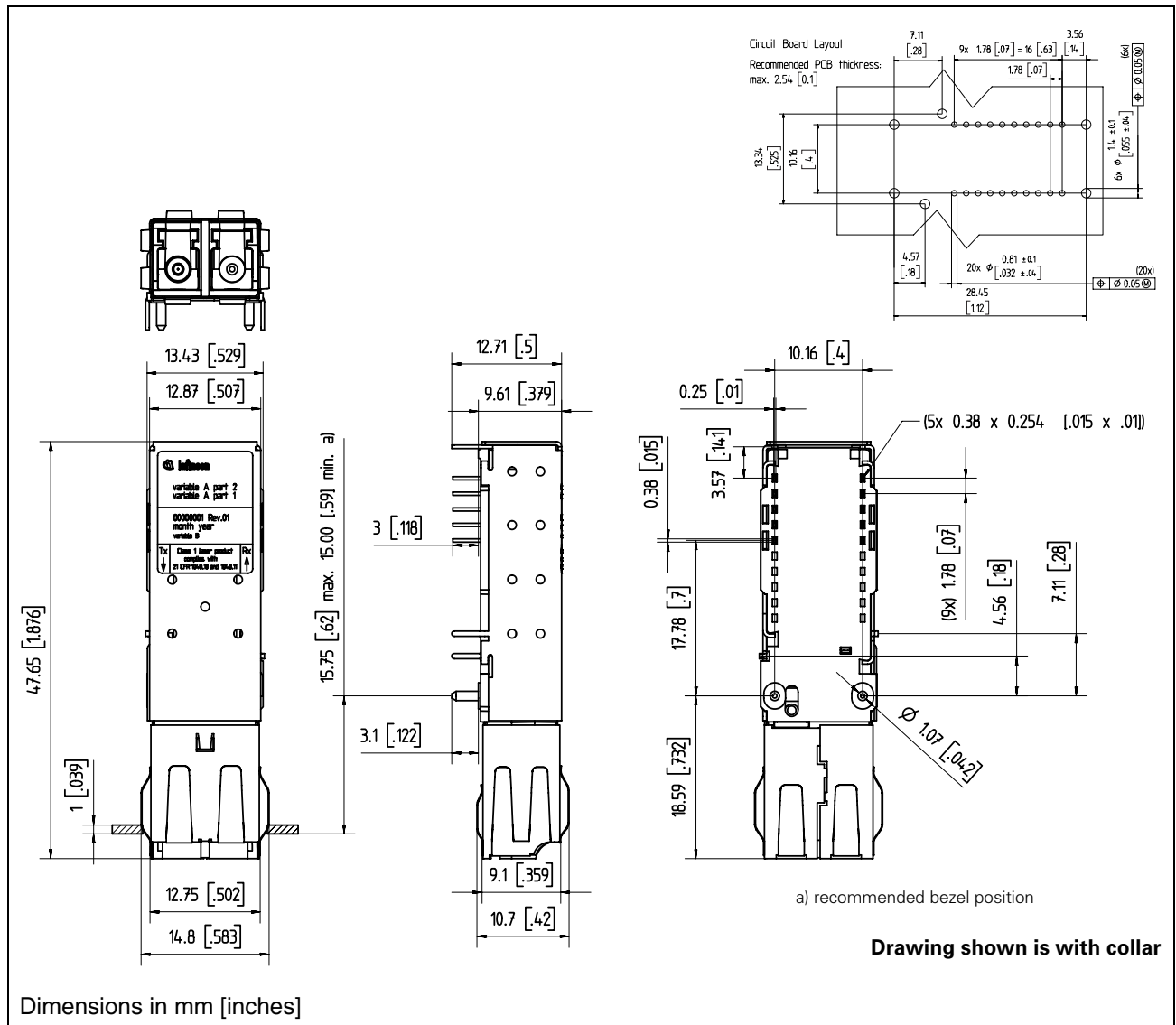


Figure 6 Transceiver Pitch

Multimode 850 nm Fibre Channel 2x5 Transceiver, AC/AC TTL

Figure 7

Values of R1/2/3/4 may vary as long as proper 50Ω termination to V_{EE} or 100Ω differential is provided. The power supply filtering is required for good EMI performance. Use short tracks from the inductor L1/L2 to the module V_{CCRx}/V_{CCTx} .

Package Outlines



V23818-M305-L57**Revision History: 2002-03-21****DS0**

Previous Version:

Page	Subjects (major changes since last revision)
	Document's layout has been changed: 2002-Aug.

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